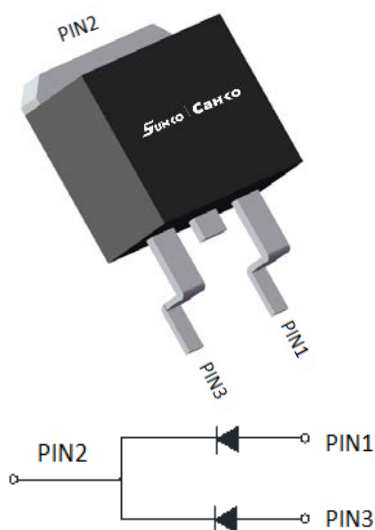


Ultra-Fast Recovery Diodes 15A*2 FRED Pt



Features

- Adopt FRED chip
- Low forward Voltage drop
- Fast reverse recovery time
- High frequency operation
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- Guard ring for enhanced ruggedness and long term reliability

Typical Applications

Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

Mechanical Data

- **Package:** TO-263
Molding compound meets UL 94 V-0 flammability rating, -
- **Terminals:** Tin plated leads, solderable per J-STD-002 and JESD22-B102
- **Polarity:** As marked

■Maximum Ratings (T_j=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	MURB3060CT
Device marking code			MURB3060CT
Repetitive Peak Reverse Voltage	V _{RRM}	V	600
Average Rectified Output Current @60Hz sine wave, R-load, T _c (FIG.1)	I _O	A	30
Surge(Non-repetitive)Forward Current @60Hz half sine-wave, 1 cycle, T _j =25°C	I _{FSM}	A	150
Current Squared Time @1ms≤t≤8.3ms T _j =25°C,	I ² t	A ² s	93
Storage Temperature	T _{stg}	°C	-55 ~ +175
Junction Temperature	T _j	°C	-55 ~ +175
Junction capacitance @4V,1MHz	C _j	pF	98

MURB3060CT

■Electrical Characteristics

PARAMETER	SYMBOL	UNIT	TEST CONDITIONS	Min	Typ	Max
Instantaneous forward voltage drop per diode	V_{FM}	V	$I_{FM}=15.0A$ @ $T_J=25^{\circ}C$	-	1.45	1.60
			$I_{FM}=15.0A$ @ $T_J=150^{\circ}C$		1.25	1.40
DC reverse current at rated DC blocking voltage per diode	I_{RRM1}	μA	$V_{RM}=V_{RRM}$ $T_J=25^{\circ}C$	-	-	5
	I_{RRM2}		$V_{RM}=V_{RRM}$ $T_J=150^{\circ}C$	-	-	200
Reverse Recovery Time	T_{rr}	ns	$I_F=0.5A$ $I_{RM}=1A$ $I_{RR}=0.25A$ $T_J=25^{\circ}C$	-	26	35-
			$T_J=25^{\circ}C$	-	115	-
			$T_J=125^{\circ}C$	-	200	-
Peak recovery current	I_{RRM}	A	$T_J=25^{\circ}C$	-	5.0	-
			$T_J=125^{\circ}C$	-	10.5	-
Reverse recovery charge	Q_{rr}	nC	$T_J=25^{\circ}C$	-	285	-
			$T_J=125^{\circ}C$	-	1000	-

■Thermal Characteristics ($T_J=25^{\circ}C$ Unless otherwise specified)

PARAMETER		SYMBOL	UNIT	MURB3060CT
Thermal Resistance	Between junction and case	$R_{\theta J-C}$	$^{\circ}C/W$	2.0
	Between junction and Air	$R_{\theta J-A}$	$^{\circ}C/W$	50

■Characteristics (Typical)

FIG1: I_o - T_c Curve

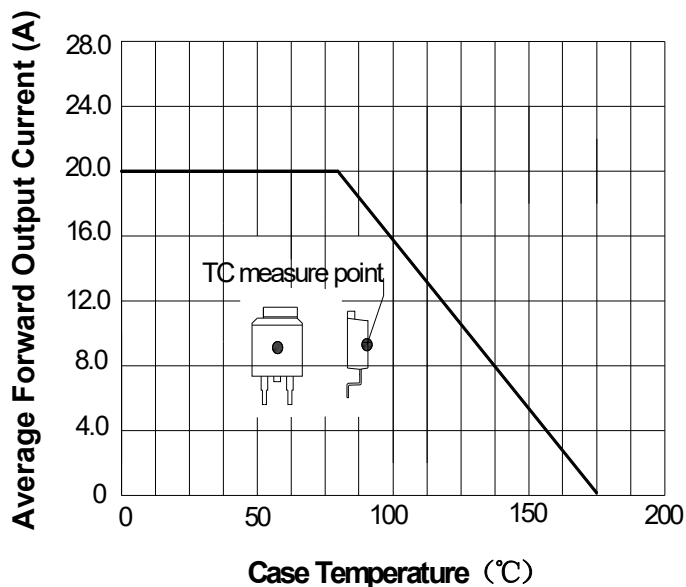


FIG2: Surge Forward Current Capability

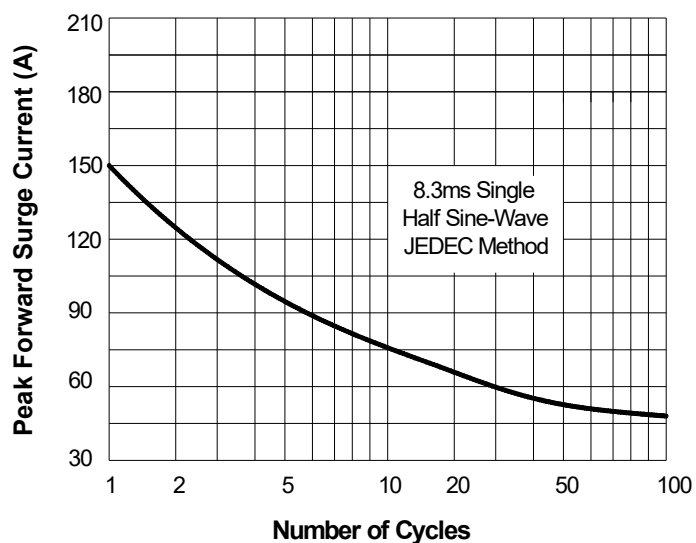


FIG3: Forward Voltage

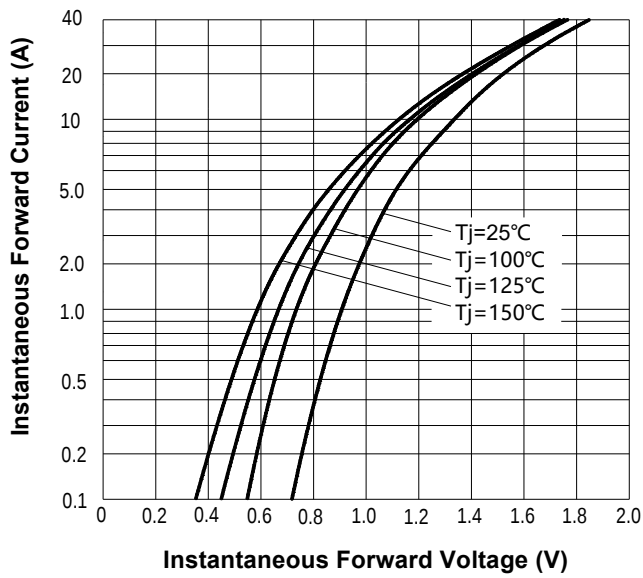


FIG.4: Instantaneous Reverse Characteristics

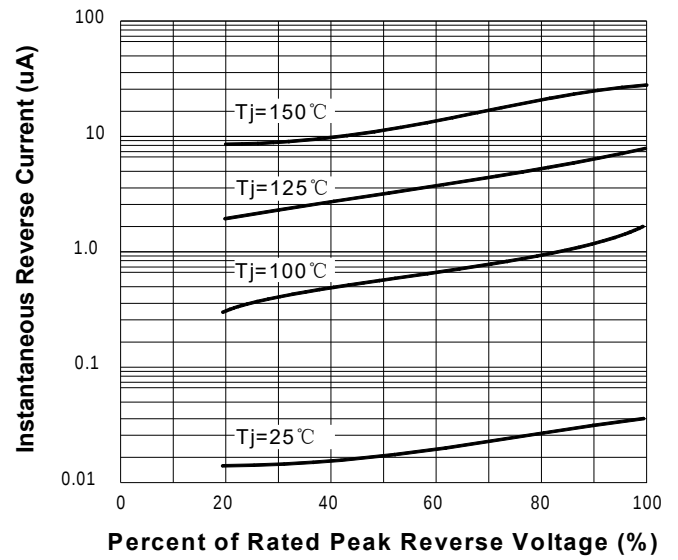
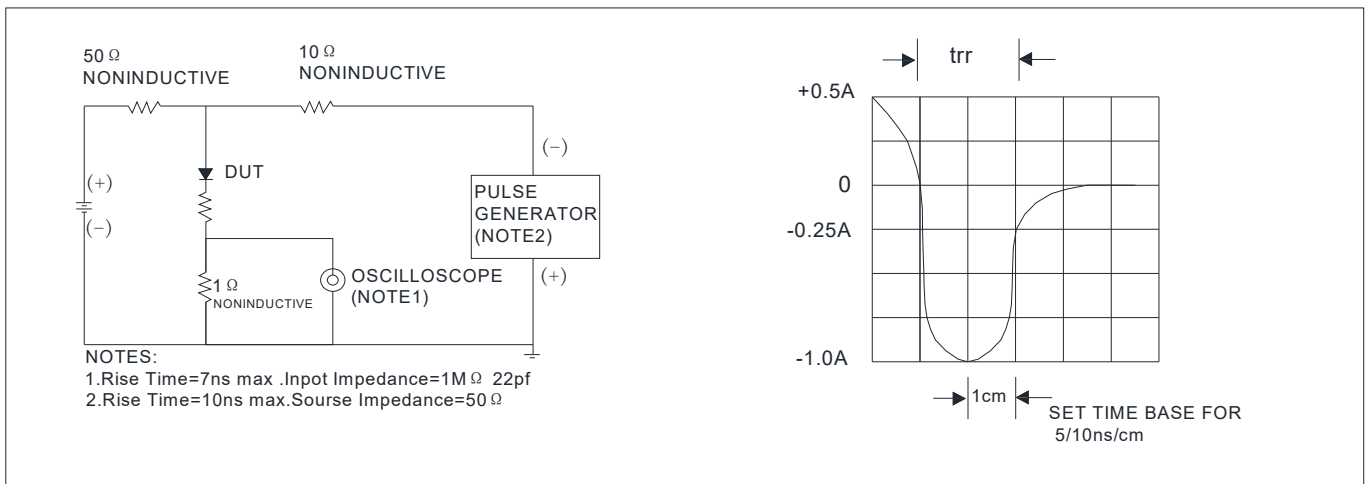
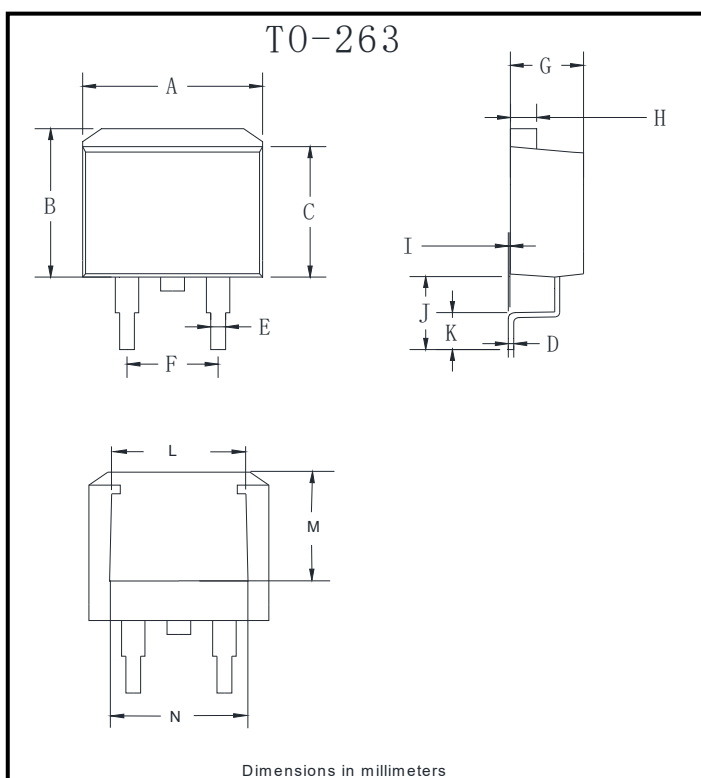


FIG.5: Diagram of circuit and Testing wave form of reverse recovery time

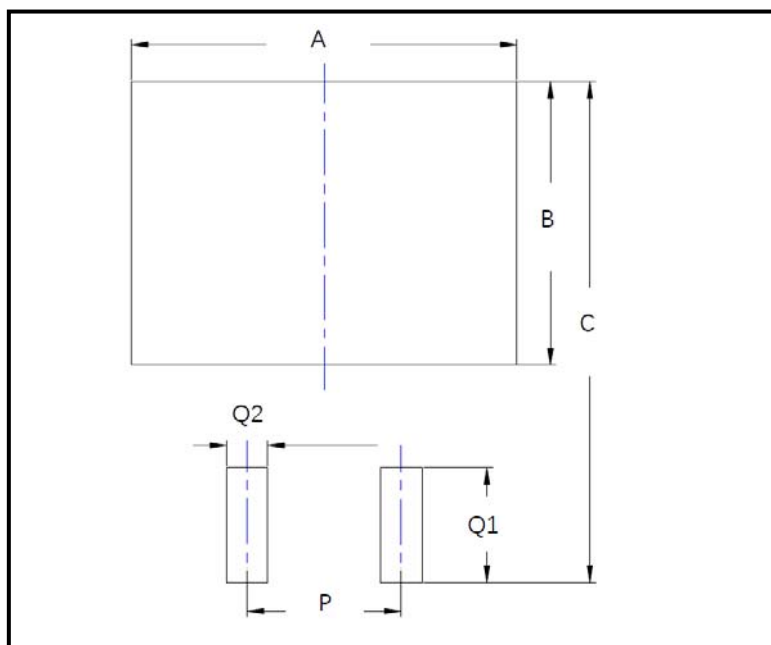


■ **Outline Dimensions**



T0-263		
Dim	Min	Max
A	9.5	11.5
B	9.7	10.5
C	8.4	9.0
D	0.28	0.64
E	0.68	0.94
F	4.55	5.6
G	4.04	5.10
H	1.14	1.4
I	0	0.2
J	4.9	6.05
K	1.79	2.79
L	7.3	7.9
M	6.2	6.8
N	7.6	8.2

■ **Suggested Pad Layout**



Dim	Millimeters
A	12.7
B	9.4
C	16.6
P	5.08
Q1	3.8
Q2	1.35

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